

# **FDMA86265P** P-Channel PowerTrench<sup>®</sup> MOSFET -150 V, -1 A, 1.2 Ω

## Features

- Max  $r_{DS(on)}$  = 1.2  $\Omega$  at  $V_{GS}$  = -10 V,  $I_D$  = -1 A
- Max  $r_{DS(on)} = 1.4 \Omega$  at  $V_{GS} = -6 V$ ,  $I_D = -0.9 A$
- Low Profile 0.8 mm maximum in the new package MicroFET 2x2 mm
- Very low RDS-on mid voltage P-channel silicon technology optimised for low Qg
- This product is optimised for fast switching applications as well as load switch applications
- 100% UIL tested
- RoHS Compliant

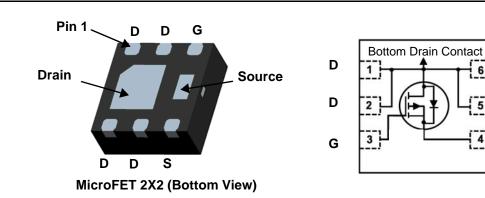


## **General Description**

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been optimized for the on-state resistance and yet maintain superior switching performance.

### Applications

- Active Clamp Switch
- Load Switch



## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Paramete	Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage			-150	V
V <sub>GS</sub>	Gate to Source Voltage			±25	V
ID	Drain Current -Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	-1	٨
	-Pulsed	-2	A		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	6	mJ
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.4	w
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1b)	0.9	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to + 150	°C

## **Thermal Characteristics**

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	52	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	145	C/VV

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
265	FDMA86265P	MicroFET 2X2	7 "	12 mm	3000 units

August 2018

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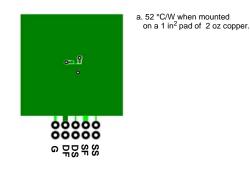
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = -250 \ \mu A, \ V_{GS} = 0 \ V$	-150			V	
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 µA, referenced to 25 °C		-125		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -120 V, V <sub>GS</sub> = 0 V			-1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \ \mu A$	-2	-3.2	-4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = -250 µA, referenced to 25 °C		5		mV/°C	
	Static Drain to Source On Resistance	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -1 A		0.86	1.2		
r <sub>DS(on)</sub>		$V_{GS} = -6 \text{ V}, \ \text{I}_{D} = -0.9 \text{ A}$		0.95	1.4		
		$V_{GS} = -10 \text{ V}, \ \text{I}_{D} = -1 \text{ A}, \text{T}_{J} = 125 \text{ °C}$		1.53	2.2		
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -10 V, I_{D} = -1 A$		1.9		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance			158	210	pF	
C <sub>oss</sub>	Output Capacitance	── V <sub>DS</sub> = -75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		16	25	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			0.7	5	pF	
R <sub>g</sub>	Gate Resistance		0.1	3	7.5	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			5.8	12	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = -75 V, I <sub>D</sub> = -1 A,		2.2	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		8	16	ns	
t <sub>f</sub>	Fall Time			6.4	13	ns	
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } -10 V V_{DD} = -75 V,$		2.8	4	nC	
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = -1 A		0.8		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			0.7		nC	

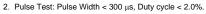
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = -1 A	(Note 2)	-0.87	-1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>E</sub> = -1 A, di/dt = 100 A/μs		50	80	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$F = -1 A, u/u = 100 A/\mu s$		78	124	nC

NOTES:

1. R<sub>0,1</sub>% is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,1</sub>C is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



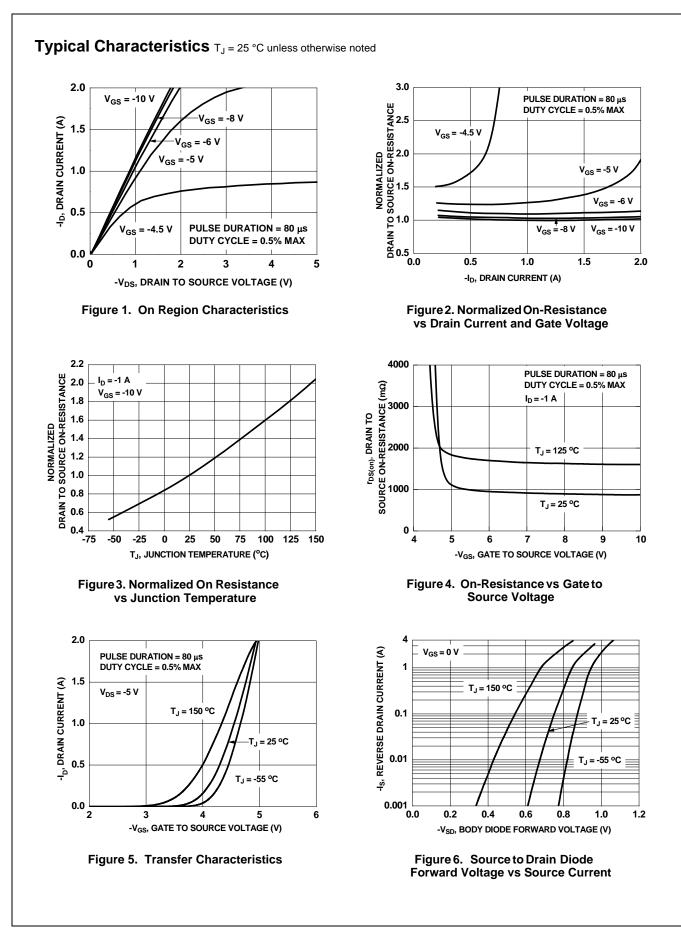
b. 145 °C/W when mounted on a minimum pad of 2 oz copper.

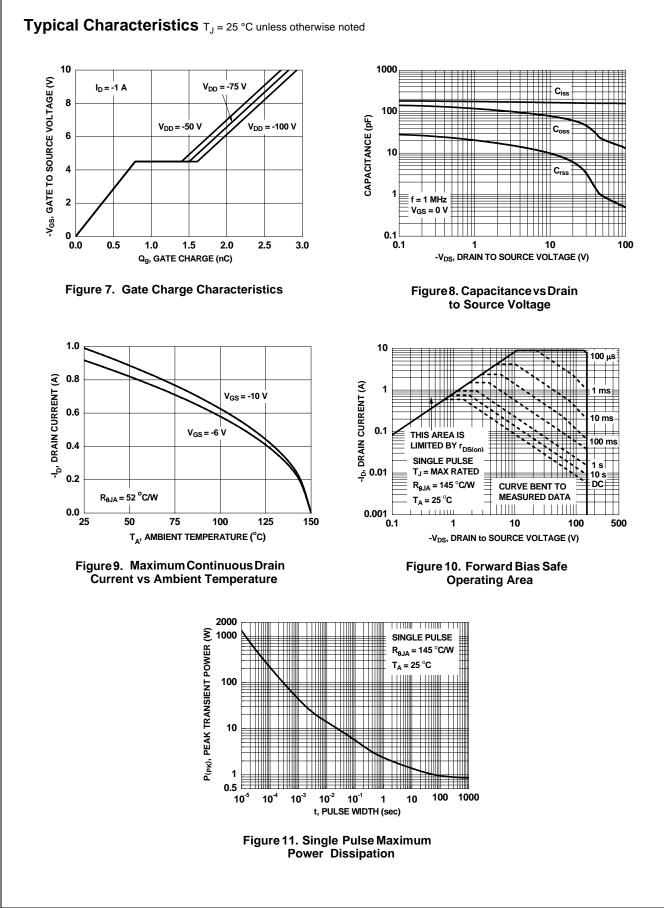


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3. Starting T_J = 25 °C; P-ch: L =3 mH, I_{AS} = -2 A, V_{DD} = -150 V, V_{GS} = -10 V.
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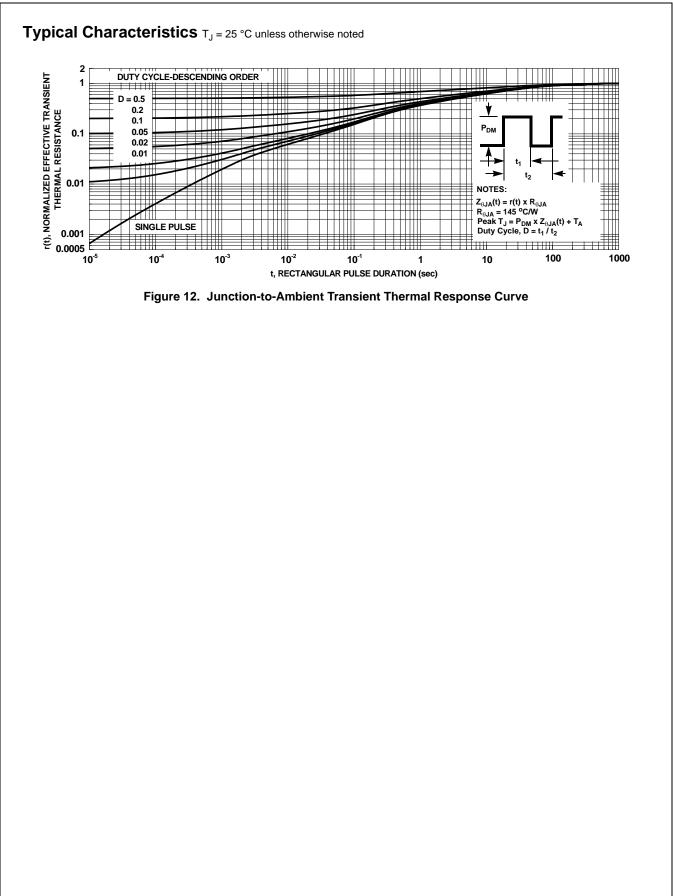
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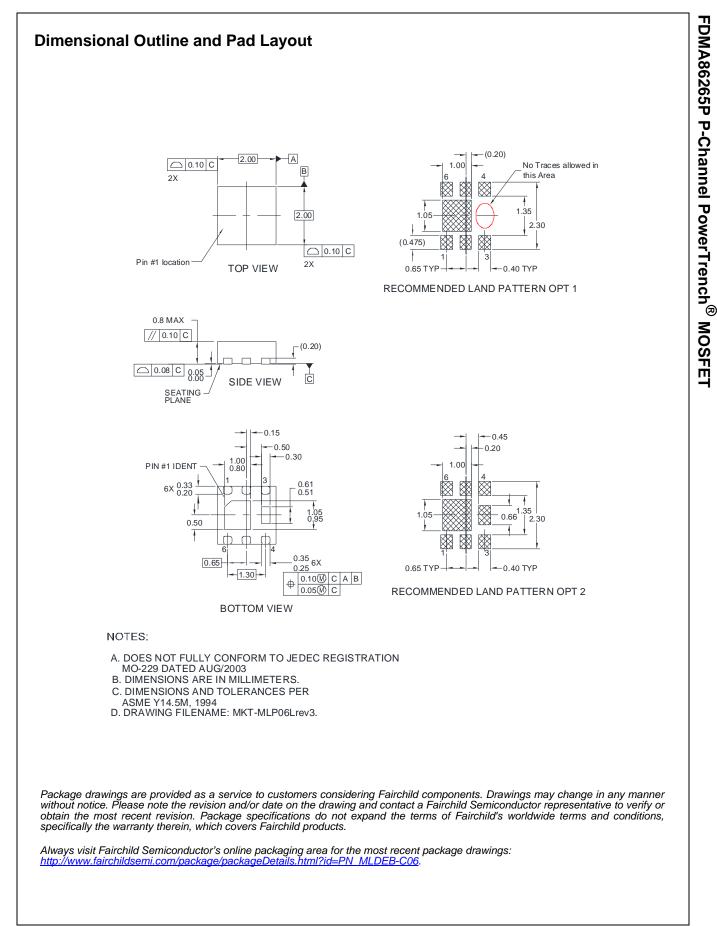
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FDMA86265P P-Channel PowerTrench<sup>®</sup> MOSFET







Datasheet Identification	Product Status	Definition
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